

ABSTRACT

Is herein disclosed a conductive polythiol type epoxy resin composition which is improved in a pot life and a storage stability as compared with the conventional polythiol type epoxy resin composition.

The present invention is a conductive resin composition comprising as essential ingredients (1) an epoxy resin having two or more epoxy groups in the molecule, (2) a polythiol compound having two or more thiol groups in the molecule, (3) a solid dispersion-type latent curing accelerator, (4) a boric acid ester compound and (5) conductive particles, and the composition is suitable for use as a conductive material in a wide range of field, including the field of electronics, where a low-temperature quick curability is required.



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